

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: M. ISHIKAWARA, et al.
Application No.: Not Yet Assigned
Filed: On Even Date Herewith
For: METHOD OF MANUFACTURING EPOXY RESIN
COMPOSITION FOR SEMICONDUCTOR ENCAPSULATING
Art Unit: Not Yet Assigned
Examiner: Not Yet Assigned

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR §§ 1.97 AND 1.98

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 25, 2005

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find an International Search Report in connection with International (PCT) Application No. PCT/JP2004/000945, of which the above-identified application is a National Stage Application filed under 35 U.S.C. § 371. Also enclosed are copies of documents cited in this International Search Report, and a copy of a document (Japanese Patent Document No. 7-314440) cited in the Specification of the above-identified application but not cited on the enclosed International Search Report. Of the documents cited in the enclosed International Search Report, Japanese Patent Document No. 3009027 (see enclosed Publication No. 09-052228) and No. 3320354 (note enclosed No. 11-267483) were also cited in the Specification of the above-identified application. As for discussions of enclosed documents in the Specification of the above-identified application, note the paragraph bridging pages 2 and 3 of the Specification of the above-identified application.

Further enclosed is a Form PTO/SB/08A, listing enclosed documents.

This Information Disclosure Statement is being submitted concurrently with the filing of the above-identified application. Accordingly, requirements of 37 CFR § 1.97(b) are clearly satisfied.

While the enclosed documents, including the enclosed International Search Report, are not in English, it is respectfully submitted that requirements of 37 CFR § 1.98(a)(3) are satisfied by the English abstracts (enclosed) for the respective Japanese patent documents, and/or description of various of these documents in the Specification of the above-identified application as mentioned previously, and/or by citation of documents in the enclosed International Search Report.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR §§ 1.97 and 1.98 have been satisfied, in connection with present submission of the enclosed documents, listed on the enclosed Form. Accordingly, consideration of the listed documents, upon examination of the above-identified application, is respectfully requested.

To the extent necessary please charge any shortage in fees due in connection with the filing of this paper, to the Antonelli, Terry, Stout & Kraus, LLP Deposit Account No. 01-2135 (Docket No. 1204.44837X00), and please credit any excess fees to such deposit account.

Respectfully submitted,

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Substitute for form 1449A/PTO		Complete if Known	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		Application Number	Not Yet Assigned
		Filing Date	On Even Date Herewith
		First Named Inventor	M. ISHIKAWARA, et al.
		Art Unit	Not Yet Assigned
		Examiner Name	Not Yet Assigned
Sheet	1	of	1
		Attorney Docket Number	1204.44837X00

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			

FOREIGN PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T ⁴
		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)				
		JP 2001-081284	03-2001	Nitto Denko Corp		Abst
		JP 06-293021	10-1994	Japan Steel Works Ltd		Abst
		JP 11-170251	06-1999	Kobe Steel Ltd		Abst
		JP 11-267483	10-1999	Kurimoto Ltd		Abst
		JP 09-052228	02-1997	Sumitomo Bakelite Co		Abst
		JP 07-314440	12-1995	Nitto Denko Corp		Abst

OTHER PRIOR ART—NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		International Search Report for International Application No. PCT/JP2004/000945, date of mailing May 25, 2004	

Examiner Signature		Date Considered	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹Applicant's unique citation designation number (optional). ²See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³Enter Office that issued the document, by the two-letter code (WIPO Standard St.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.

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